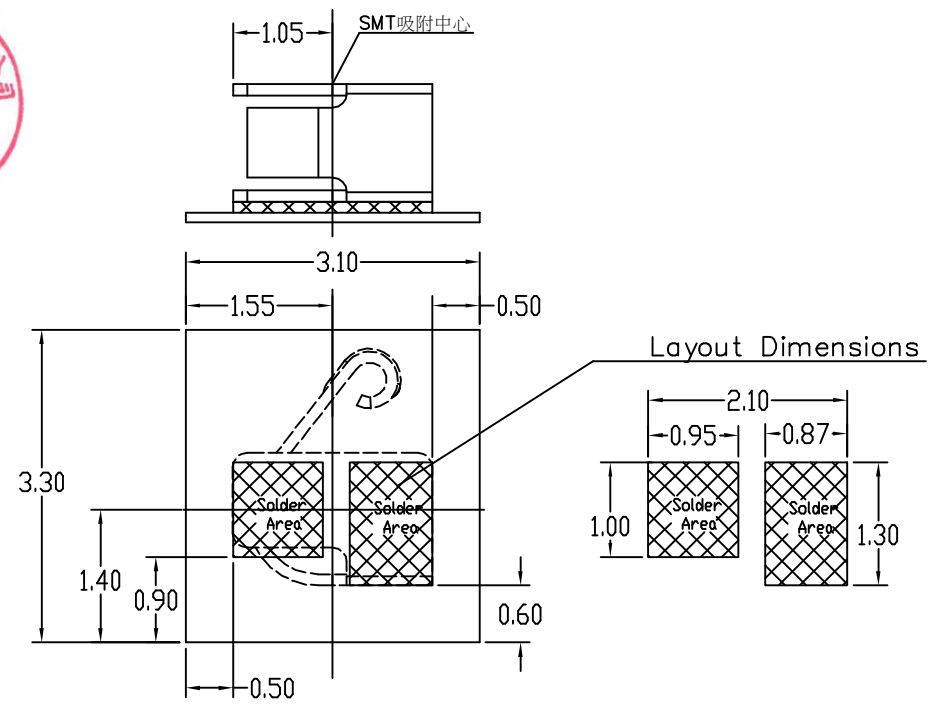
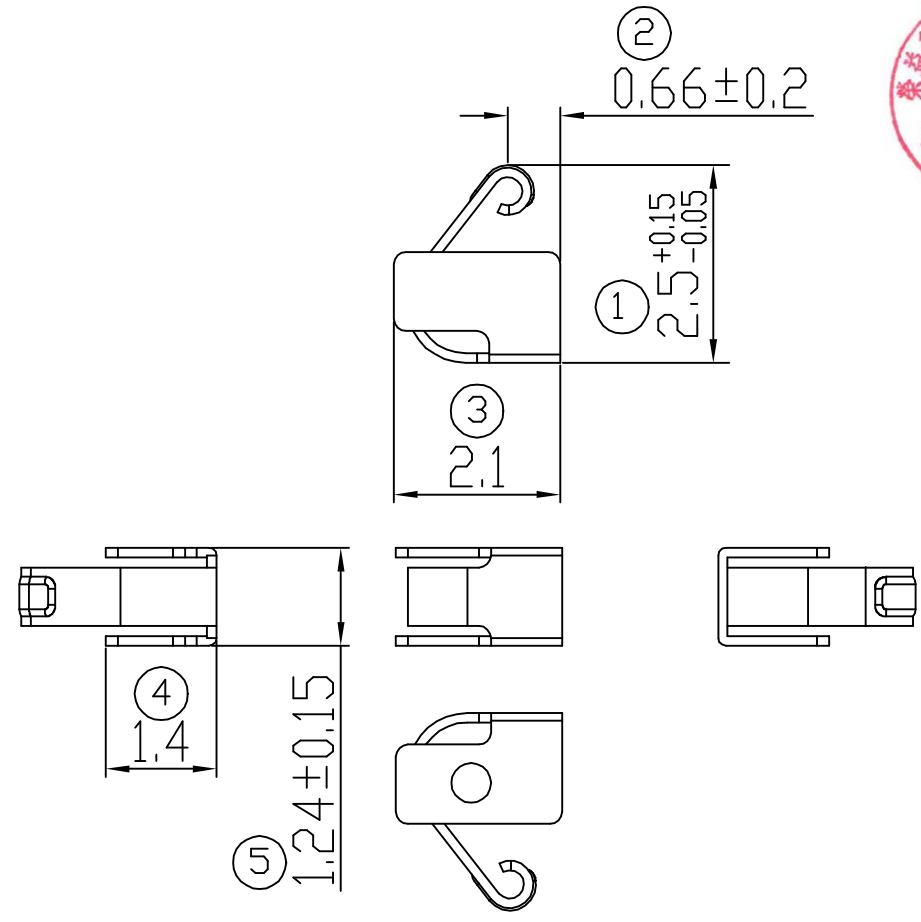


A
B
C
D
E
F

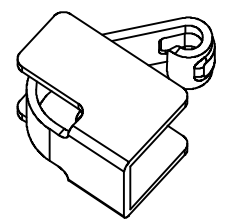
A
B
C
D
E
F



RECOMMENDED SOLDERING PCB LAYOUT

TOLERANCE(.XX±0.05)

- Note:
- 1. Material: Titanium Copper Thickness 0.12mm
 - 2. Electroplate:
 - Gold Flash on contact area
 - Gold Flash on solder area
 - Nickel underplating over all
 - 3.Electrical Characteristics:
 - 3-1 Current Voltage: 12V
 - 3-2 Current Rate: 3A
 - 3-3 Contact Resistance: Normal Compression<30mΩ
 - 4.Working Range of Application: 0.30~0.45 mm
 - 5.Spring Force Tolerance is ±20gf
 - 6.Operating Temperature: -20℃~+85℃



TOLERANCE/CLASS			
RANGE(mm)	1	2	3
≤30	±0.10	0.15	0.20
30<~ ≤120	±0.15	0.20	0.30
120<~ ≤300	±0.20	0.30	0.50
300<	±0.30	0.50	0.80
ANGLES	±2.5°		

00	02/10-'15	Design creation	
REV	Date	Description	
DRAFT	Danny Liao	DATE	02/10-'15
CHECKER	Justin Wu	DATE	02/10-'15
APPROVAL	Jacky Lin	DATE	02/10-'15
SHEET	1-2	SCALE	Not to scale
UNIT	mm		

RoHS
Compatible



EMI STOP CORP.

EMISTOP
JC-252113G

CUS P/N